

## STATEMENT OF "RoHS" COMPLIANCE

We hereby certify that the products listed below are RoHS compliant in conformity with the relevant E.U. directive coming to enforcement on July 1, 2006

models	Product descriptions	production lot or serial numbers to identify		productions since
CT-S2000 PF/RF	Thermal printer	05Y0001 onward	such as 05Zxxxx, 061xxxx	Nov 2005
CT-S300 PF/RF	Thermal printer	0590151	- do - 05Xxxxx,05Yxxxx,05Zxxxx,061xxxx, 062xxxx	Sept 2005
CT-S300 UF	Thermal printer	0670865	- do -	July 2006
CT-S280 PF/RF/UB	Thermal printer	05Y0251	- do -	Dec 2005
CBM1000-II PF/RF	Thermal printer	05Y1629	- do -	Nov 2005
CBM1000-II UF	Thermal printer	0652132	- do -	May 2006
CBM262 PF/RF	Thermal printer	PC1003151	- do -	Nov 2005
CBM270 PF/RF	Thermal printer	TBA		Aug 2006
CBM270L PF/RF	Thermal printer	TBA		Sept 2006
CBM291	Thermal printer	0630739	- do -	Mar 2006
CBM293	Thermal printer	0630689	- do -	Mar 2006
CMP-10	Thermal printer	0650201	- do -	May 2006
CMP-10BT	Thermal printer	0650201	- do -	May 2006
PPU231	Thermal printer	0660001	- do -	June 2006
PHU131/PHU132	Paper holder	064101	- do -	Apr 2006
PPU700PU/RU	Thermal printer	0610486	- do -	Jan 2006
PHU331/PHU332	Paper holder	061101	- do -	Jan 2006
C2202PDE	Customer display	C55006200056	- do -	Mar 2006

### Substances abolished

\* Definition of chemical substances is subject to related laws and regulations (RoHS directive).

- Cadmium and its compounds
- Chromium(VI) compounds
- Lead and its compounds
- Mercury and its compounds
- Polybrominated biphenyls (PBB)
- Polybrominated diphenyl ethers (PBDE)

### EXEMPTIONS (Cases permitted to contain)

Cadmium for plating electric contact without a substitute

Chromium VI for specific rust free application (for cooling carbon steel for refrigerator)

Lead contained in high-melting-point solder with lead content 85% or more for internal connection of parts

Lead in electronic ceramic part (ex: Piezo element)

Lead in glass of electronic component (including fluorescent tube, cathode ray tube)

Lead of less than 0.35wt% in steel, lead of less than 0.4wt% in aluminum, and lead of less than 4wt% in copper as alloy component

Mercury of less than 5 mg per lamp for small-size fluorescent lamp (backlight of LCD, etc.)

Mercury in lamp other than small-size fluorescent light and straight type fluorescent lamp

Cadmium, chromium VI, lead, mercury in battery cell (based on European battery directive)

## CITIZEN SYSTEMS JAPAN CO., LTD.

6-1-12, Tanashi-cho, Nishi-Tokyo-shi, Tokyo, Japan

tel 81-424-68-4608

signed by Yasuo ICHIKAWA  
 title Manager  
 division Production Engineering dept

  
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IDP3420	dot impact printer	0640001 onward such as 065xxxx, 066xxx	Apr 2006
IDP3421	dot impact printer	0670145 - do -	July 2006
IDP3423	dot impact printer	TBA	TBA
IDP3550	dot impact printer	0640907 - do -	Apr 2006
IDP3551	dot impact printer	0640907 - do -	Apr 2006
CD-S500 PF/RF	dot impact printer	NJ20001859 - do -	Jan 2006
CD-S501 PF/RF	dot impact printer	NJ40002072 - do -	Jan 2006
CD-S503 PF/RF	dot impact printer	NJ60000375 - do -	Feb 2006
CBM910-II	dot impact printer	0640001 - do -	Apr 2006
CBM920-II	dot impact printer	0671237 - do -	July 2006
CBM820	receipt slip printer	9605 607 00001 - do -	July 2006
AW-3	paper winder	061100 - do -	Jan 2006
AW-5	paper winder	061104 - do -	Jan 2006

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